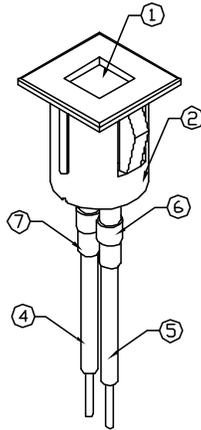
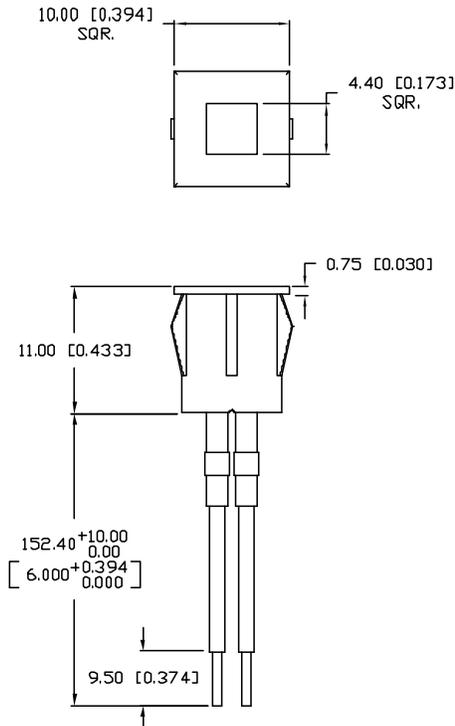


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PART NUMBER  
SSI-LXH55GD-150

REV.



ELECTRO-OPTICAL CHARACTERISTICS  $T_A=25^{\circ}\text{C}$   $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		2.2	2.6	$V_f$	
REVERSE VOLTAGE	5.0			$V_r$	$I_f=100\mu\text{A}$
AXIAL INTENSITY		10		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		110		$2x$ theta	
EMITTED COLOR:	GREEN				
EPOXY LENS FINISH:	GREEN DIFFUSED				

LIMITS OF SAFE OPERATION AT  $25^{\circ}\text{C}$

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	105	mW
DERATE FROM $25^{\circ}\text{C}$	-1.6	mW/ $^{\circ}\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^{\circ}\text{C}$

\*  $t < 10\mu\text{s}$

NOTES:

- SSH-LXH55, BLACK NYLON HOLDER.
- SSL-LX5573GD, GREEN LED.
- PANEL CUT OUT: 8.45mm [0.345] SQR.
- ANODE LEAD: LXP-WST24RDTC, 24 AWG. TINNED OVERCOAT WIRE, RED INSULATION, CUT 150mm LONG, STRIP 3mm & 9.5mm.
- CATHODE LEAD: LXP-WST24BLTC, 24 AWG. TINNED OVERCOAT WIRE, BLACK INSULATION, CUT 150mm LONG, STRIP 3mm & 9.5mm.
- CRIMP WIRE LEADS TO LED LEADS.
- 32mm 1/16" BLACK HEAT SHRINK TUBING. (2 PCS.)

\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION -0.00, MAX.= +0.00 -DECIMAL PRECISION

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REV. PART NUMBER  
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5mm x 5mm 565nm GREEN LED PANEL INDICATOR,  
GREEN DIFFUSED LENS, 6" WIRE LEADS.

RELIABILITY NOTE  
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: BC	CHECKED BY:	APPROVED BY:	DATE: 5.29.03
			PAGE: 1 OF 1
			SCALE: N/A